

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Chong Chin Hui, et al. >

Serial No.: 09/982,595

Filed:

10/18/2001

For:

Die Pad for Integrated Circuits

Docket No.: TI-27874

H6/B Andt Muller Examiner: Parekh, Nitin (

Art Unit:

2811

Amendment under 37 CFR 1.111

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450 MAILING CERTIFICATE UNDER 37 C.F.R. \$1,8(A)

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-

1450 on

Michael K. Skrehot, Reg. No. 36,682

Dear Sir:

The following amendments and remarks are offered in response to the Examiner's Office Action dated 02/05/03. They are respectfully submitted as a full and complete response to that Action. Applicant hereby petitions for a one month extension of time for the filing of this response. The Commissioner is hereby requested and authorized to charge any fees necessary for the filing of the enclosed papers to deposit account number 20-0668 of Texas Instruments Incorporated.